



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

Warren M. Farnworth

**Serial No.:** 10/731,956

**Filed:** December 9, 2003

**For:** UNDERFILL AND  
ENCAPSULATION OF CARRIER  
SUBSTRATE-MOUNTED FLIP-CHIP  
COMPONENTS USING  
STEREOLITHOGRAPHY

**Confirmation No.:** 6751

**Examiner:** C. Nguyen

**Group Art Unit:** 2811

**Attorney Docket No.:** 2269-3924.3US  
(99-0034.3/US)

**Notice of Allowance Mailed:**

June 22, 2004

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Person making Deposit: Christopher Haughton

**AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)**

Mail Stop ISSUE FEE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

Sir:

Please amend the above-referenced application as follows:

**Amendments to the Specification** begin on page 3 of this paper.

**Amendments to the Abstract** appear on page 20 of this paper.

**Amendments to the Drawings** appear on page 21 of this paper and include both an attached replacement sheet and an annotated sheet showing changes.

**Remarks** begin on page 22 of this paper.

An **Appendix** including amended drawing figures is attached following page 22 of this paper.